

Special Issue

Editorial Board Members' Collection Series: Intelligent Manufacturing

Message from the Guest Editors

It is our pleasure to announce that *Journal of Manufacturing and Materials Processing (JMMP)*, Tracked for Impact, CiteScore 4.8) plans to publish a Special Issue entitled "Editorial Board Members' Collection Series: Intelligent Manufacturing". This will be a collection of feature papers contributed by our Editorial Board Members and their invitees. All feature papers in this Collection will receive full waivers while enjoying benefits stemming from open access and *JMMP* promotions and highlights. Papers from all related areas are within the scope of this Collection, including but not limited to:

- Monitoring, sensing, dynamic modeling, and control of manufacturing processes;
- Robotic manufacturing systems/processes;
- Human-robotic collaborative manufacturing systems/processes;
- Use of machine vision, machine learning, data fusion, optimization, and other advanced techniques/algorithms to improve the operation, quality, and productivity of manufacturing processes;
- Sensing, monitoring, and control of additive manufacturing, including wire arc additive manufacturing processes.

Guest Editors

Prof. Dr. Yu-Ming Zhang

Prof. Dr. Shanben Chen

Prof. Dr. Sharifu Ura

Deadline for manuscript submissions

closed (1 March 2024)



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Impact Factor 3.3
CiteScore 5.2



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About the Journal

Message from the Editor-in-Chief

Journal of Manufacturing and Materials Processing (JMMP) (ISSN 2504-4494) is a new MDPI peer-reviewed, open access venue with a focus on the scientific fundamentals and engineering methodologies of manufacturing and materials processing. We offer an online platform facilitating effective exchange of innovative scientific and engineering ideas and the dissemination of recent, original, and significant research and developmental findings. On behalf of the Editorial Board, I extend an invitation to our scientific and engineering colleagues to contribute high-quality, innovative, and ground-breaking research articles to *JMMP*.

Editor-in-Chief

Prof. Dr. Steven Y. Liang

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Author Benefits

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Journal Rank:

JCR - Q2 (Engineering, Mechanical) / CiteScore - Q2
(Mechanical Engineering)

Rapid Publication:

manuscripts are peer-reviewed and a first decision is
provided to authors approximately 15.9 days after
submission; acceptance to publication is undertaken in 3.5
days (median values for papers published in this journal in
the second half of 2025).